

8961726 TEXAS INSTR (OPT0)

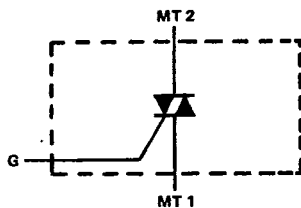
62C 36724 D

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC216E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS  
REVISED OCTOBER 1984

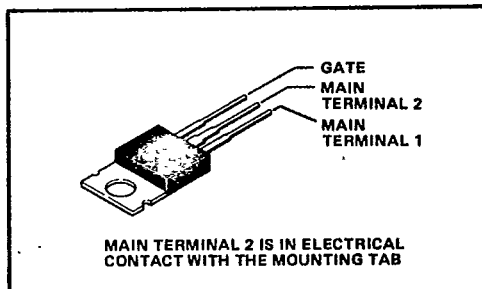
T-25-15

- Sensitive-Gate Triacs
- 100 V to 800 V
- 8 A RMS; 70 A Peak
- MAX IGT of 5 mA (Quadrant 1-3)

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	TIC226A	TIC226B	TIC226C	TIC226D
Repetitive peak off-state voltage, $V_{DRM}$ (see Note 1)	100 V	200 V	300 V	400 V
Full-cycle RMS on-state current at (or below) 85°C case temperature $I_T(RMS)$ (see Note 2)	8 A			
Peak on-state surge current, full-sine-wave, $I_{TSM}$ (see Note 3)	70 A			
Peak on-state surge current half-sine-wave, $I_{TSM}$ (see Note 4)	80 A			
Peak gate current, $I_{GM}$	1			
Peak gate power dissipation, $P_{GM}$ at (or below) 85°C case temperature (pulse duration $\leq 200 \mu s$ )	2.2 W			
Average gate power dissipation, $P_{G(av)}$ , at (or below) 85°C case temperature (see Note 5)	0.9 W			
Operating case temperature range	- 40°C to 110°C			
Storage temperature range	- 40°C to 125°C			
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	230°C			

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.  
 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 85°C derate linearly to 110°C case temperature at the rate of 120 mA/°C.  
 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.  
 4. This value applies for one 50-Hz half-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge gate control may be lost.  
 5. This value applies for a maximum averaging time of 20 ms.

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TIC Devices

8961726 TEXAS INSTR (OPTO)

62C 36725 D

T-25-15

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC226E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	TIC226E	TIC226M	TIC226S	TIC226N
Repetitive peak off-state voltage, $V_{DRM}$ (see Note 1)	500 V	600 V	700 V	800 V
Full-cycle RMS on-state current at (or below) 85°C case temperature	8 A			
$I_T(RMS)$ (see Note 2)	8 A			
Peak on-state surge current, full-sine-wave, $I_{TSM}$ (see Note 3)	70 A			
Peak on-state surge current half-sine-wave, $I_{TSM}$ (see Note 4)	80 A			
Peak gate current, $I_{GM}$	1			
Peak gate power dissipation, $P_{GM}$ at (or below) 85°C case temperature (pulse duration $\leq 200 \mu s$ )	2.2 W			
Average gate power dissipation, $P_{G(av)}$ , at (or below) 85°C case temperature (see Note 5)	0.9 W			
Operating case temperature range	- 40°C to 110°C			
Storage temperature range	- 40°C to 125°C			
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	230°C			

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1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.
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  4. This value applies for one 50-Hz half-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge gate control may be lost.
  5. This value applies for a maximum averaging time of 20 ms.

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TIC Devices

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62C 36726 D

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC226E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS

electrical characteristics at 25°C case temperature (unless otherwise noted)

7-25-15

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I <sub>DRM</sub> Repetitive Peak Off-State Current	V <sub>DRM</sub> = Rated V <sub>DRM</sub> , I <sub>G</sub> = 0, T <sub>C</sub> = 110°C			± 2	mA
I <sub>GTM</sub> Peak Gate Trigger Current	V <sub>supply</sub> = +12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			2 50	mA
	V <sub>supply</sub> = +12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			-12 -50	
	V <sub>supply</sub> = -12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			-9 -50	
	V <sub>supply</sub> = -12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			20	
V <sub>GTM</sub> Peak Gate Trigger Voltage	V <sub>supply</sub> = +12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			0.7 2	V
	V <sub>supply</sub> = +12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			-0.8 -2	
	V <sub>supply</sub> = -12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			-0.8 -2	
	V <sub>supply</sub> = -12 V†, R <sub>L</sub> = 10 Ω, t <sub>w(g)</sub> ≥ 20 μs			0.9 2	
V <sub>TM</sub> Peak On-State Voltage	I <sub>TM</sub> = ± 12 A, I <sub>G</sub> = 50 mA, See Note 6			± 1.6 ± 2.1	V
I <sub>H</sub> Holding Current	V <sub>supply</sub> = +12 V†, I <sub>G</sub> = 0, Initiating I <sub>TM</sub> = 100 mA			5 30	mA
	V <sub>supply</sub> = -12 V†, I <sub>G</sub> = 0, Initiating I <sub>TM</sub> = -100 mA			-9 -30	
I <sub>L</sub> Latching Current	V <sub>supply</sub> = +12 V†, See Note 7			50	mA
	V <sub>supply</sub> = -12 V†, See Note 7			-50	
dv/dt Critical Rate of Rise of Off-State Voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub> , I <sub>G</sub> = 0, T <sub>C</sub> = 110°C			100	V/μs
dv/dt(c) Critical Rise of Commutation Voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub> , I <sub>TRM</sub> = ± 4.2 A, T <sub>C</sub> = 85°C See Figure 9			5	V/μs

† All voltages are with respect to Main Terminal 1.

- NOTES: 6. These parameters must be measured using pulse techniques, t<sub>w</sub> ≤ 1 ms, duty cycle ≤ 2%. Voltage-sensing contacts, separate from the current-carrying contacts, are located within 3.2 mm (1/8 inch) from the device body.  
7. The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics: R<sub>G</sub> = 100 Ω, t<sub>w</sub> = 20 μs, t<sub>r</sub> ≤ 15 ns, t<sub>f</sub> ≤ 15 ns, f = 1 kHz.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>			1.8	°C/W
R <sub>θJA</sub>			62.5	



TIC Devices

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62C 36727 D

T-25-15

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC226E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS

TYPICAL CHARACTERISTICS

GATE TRIGGER CURRENT  
vs  
CASE TEMPERATURE

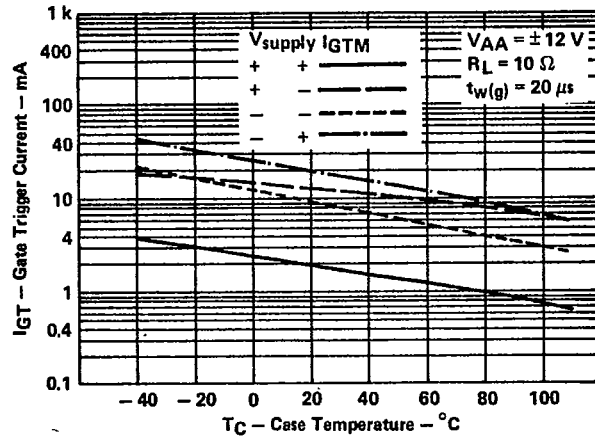


FIGURE 1

GATE TRIGGER VOLTAGE  
vs  
CASE TEMPERATURE

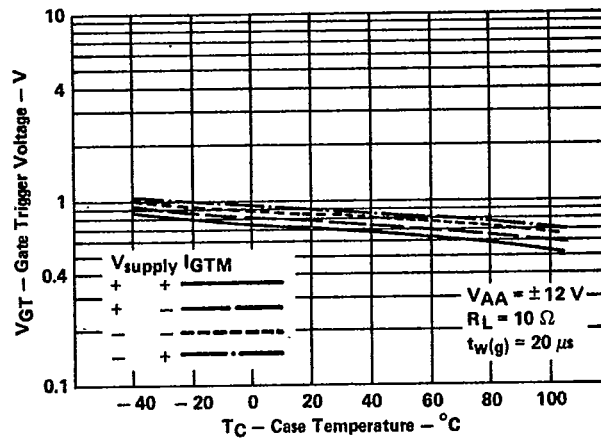


FIGURE 2



TIC Devices

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62C 36728 D

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC226E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS

TYPICAL CHARACTERISTICS

T-25-15

HOLDING CURRENT  
vs  
CASE TEMPERATURE

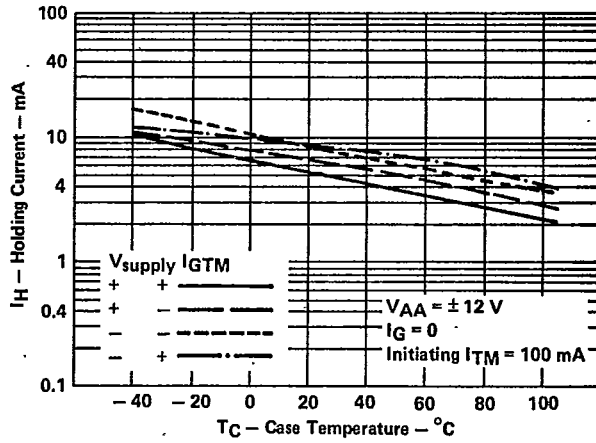


FIGURE 3

GATE FORWARD VOLTAGE  
vs  
GATE FORWARD CURRENT

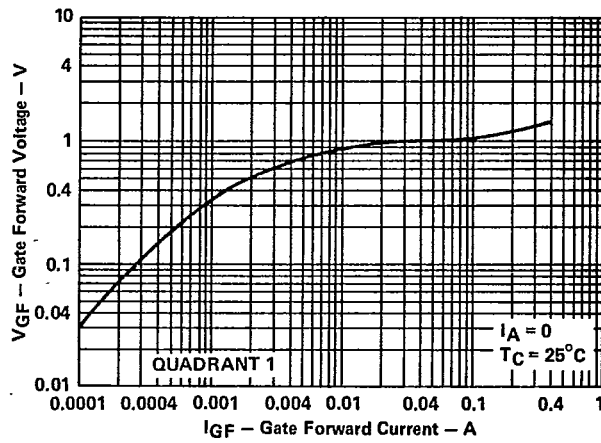


FIGURE 4

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TIC Devices

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62C 36729 D

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC226E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS

T-25-15

TYPICAL CHARACTERISTICS

LATCHING CURRENT  
vs  
CASE TEMPERATURE

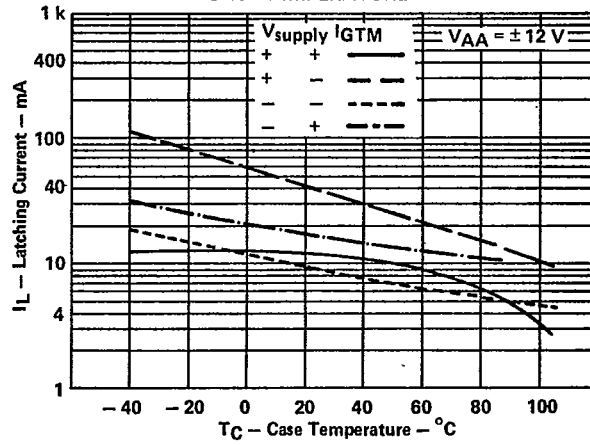


FIGURE 5

THERMAL INFORMATION

SURGE ON-STATE CURRENT  
vs  
CYCLES OF CURRENT DURATION

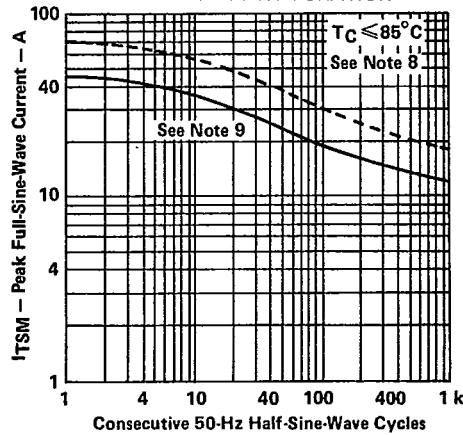


FIGURE 6

- NOTES: 8. The dashed curve shows the maximum number of cycles of surge current recommended for safe operation provided the device is initially operating at, or below, the rated value of on-state current; however, during the surge period gate control of the device is initially at nonoperating thermal equilibrium.  
9. The solid curve shows the maximum number of cycles of surge current for which gate control is guaranteed provided the device is initially at nonoperating thermal equilibrium.

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TIC Devices

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62C 36730 D

TIC226A, TIC226B, TIC226C, TIC226D,  
TIC226E, TIC226M, TIC226S, TIC226N  
SILICON TRIACS

T-25-15

THERMAL INFORMATION

MAXIMUM RMS ON-STATE CURRENT  
vs  
CASE TEMPERATURE

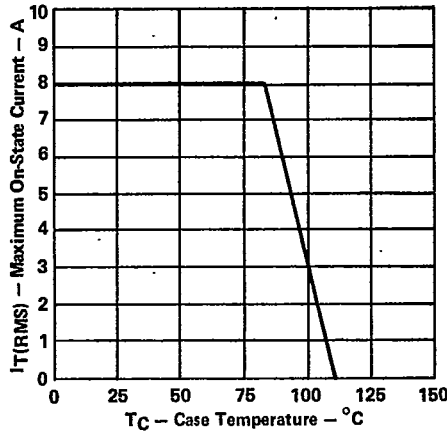


FIGURE 7

MAXIMUM AVERAGE POWER DISSIPATED  
vs  
RMS ON-STATE CURRENT

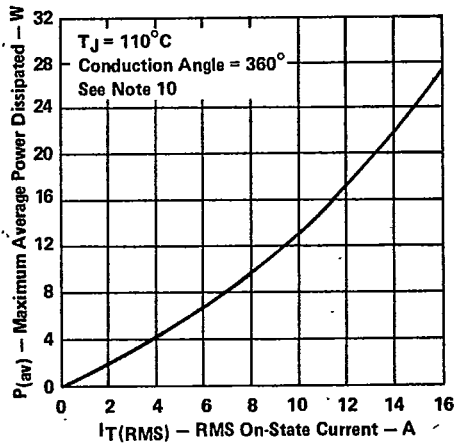


FIGURE 8

NOTE 10: For operation at current greater than 8 amps rms, see Figure 6.



TIC Devices